



Extended Voltage Calling Number Identification Circuit 2

Data Sheet

April 2006

Features

- Compatible with:
 - British Telecom (BT) SIN227 & SIN242
 - U.K.'s Cable Communications Association (CCA) specification TW/P&E/312
 - Bellcore GR-30-CORE (formerly known as TR-NWT-000030) & SR-TSV-002476
- Bellcore "CPE Alerting Signal (CAS)" and BT "Idle State Tone Alert Signal" detection
- Ring and line reversal detection
- 1200 baud Bell 202 and CCITT V.23 Frequency Shift Keying (FSK) demodulation
- 3 or 5 V ±10% supply voltage
- High input sensitivity (-40 dBV Tone and FSK Detection)
- Selectable 3-wire data interface (microcontroller or MT88E43 controlled)
- · Low power CMOS with powerdown mode
- · Input gain adjustable amplifier
- Carrier detect status output
- Uses 3.58 MHz crystal

Applications

 BT Calling Line Identity Presentation (CLIP), CCA CLIP, and Bellcore Calling Identity Delivery (CID) systems

Ordering Information

	MT88E43BE MT88E43BS MT88E43BSR MT88E43BS1 MT88E43BSR1 *Pb	24 Pin SOIC*	Tubes Tubes Tape & Reel Tubes Tape & Reel					
-40°C to +85°C								

- Feature phones, including Analog Display Services Interface (ADSI) phones
- Phone set adjunct boxes
- · FAX and answering machines
- Database query and Computer Telephony Integration (CTI) systems

Description

The MT88E43 Calling Number Identification Circuit 2 (ECNIC2) is a low power CMOS integrated circuit intended for receiving physical layer signals transmitted according to BT (British Telecom) SIN227 & SIN242, the U.K.'s CCA (Cable Communications Association) TW/P&E/312 and Bellcore GR-30-CORE & SR-TSV-002476 specifications. The MT88E43 is suitable for applications using a fixed voltage power source between 3 and 5 V \pm 10%.

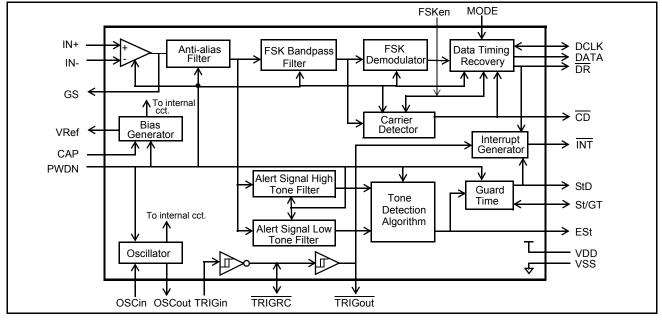


Figure 1 - Functional Block Diagram

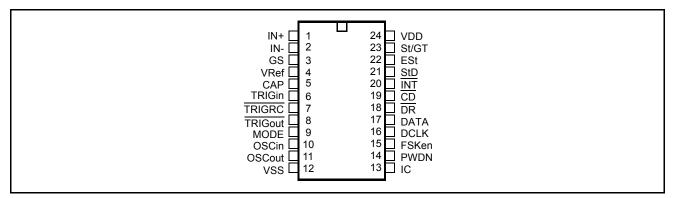


Figure 2 - Pin Connections

Pin Description

Pin #	Name	Description
1	IN+	Non-inverting Input of the internal opamp.
2	IN-	Inverting Input of the internal opamp.
3	GS	Gain Select (Output) of internal opamp. The opamp's gain should be set according to the nominal Vdd of the application using the information in Figure 10.
4	V _{Ref}	Reference Voltage (Output) . Nominally $V_{DD}/2$. It is used to bias the input opamp.
5	CAP	Capacitor. A 0.1 μ F decoupling capacitor should be connected across this pin and V _{SS} .
6	TRIGin	Trigger Input. Schmitt trigger buffer input. Used for line reversal and ring detection.
7	TRIGRC	Trigger RC (Open Drain Output/Schmitt Input) . Used to set the (RC) time interval from TRIGin going low to TRIGout going high. An external resistor connected to V_{DD} and capacitor connected to V_{SS} determine the duration of the (RC) time interval.
8	TRIGout	Trigger Out (CMOS Output). Schmitt trigger buffer output. Used to indicate detection of line reversal and/or ringing.
9	MODE	3-wire interface: Mode Select (CMOS Input) . When low, selects interface mode 0. When high, selects interface mode 1. See pin 16 (DCLK) description to understand how MODE affects the DCLK pin.
10	OSCin	Oscillator Input . A 3.579545 MHz crystal should be connected between this pin and OSCout. It may also be driven directly from an external clock source.
11	OSCout	Oscillator Output . A 3.579545 MHz crystal should be connected between this pin and OSCin. When OSCin is driven by an external clock, this pin should be left open.
12	V _{SS}	Power Supply Ground.
13	IC	Internal Connection. Must be connected to V _{SS} for normal operation.
14	PWDN	Power Down (Schmitt Input) . Active high. When high, the device consumes minimal power by disabling all functionality except TRIGin, TRIGRC and TRIGout. Must be pulled low for device operation.
15	FSKen	FSK Enable (CMOS Input) . Must be high for FSK demodulation. This pin should be set low to prevent the FSK demodulator from reacting to extraneous signals (such as speech, alert signal and DTMF which are all in the same frequency band as FSK).
16	DCLK	3-wire Interface: Data Clock (CMOS Input/Output) . In mode 0 (MODE pin low), this pin is an output. In mode 1 (MODE pin high), this pin is an input.

Pin Description

Pin #	Name	Description
17	DATA	3-wire Interface: Data (CMOS Output) . In mode 0 data appears at the pin once demodulated. In mode 1 data is shifted out on the rising edge of the microcontroller supplied DCLK.
18	DR	3-wire Interface: Data Ready (CMOS Output) . Active low. In mode 0 this output goes low after the last DCLK pulse of each data word. This identifies the 8-bit word boundary on the serial output stream. Typically, DR is used to latch 8-bit words from a serial-to-parallel converter into a microcontroller. In mode 1 this pin will signal the availability of data.
19	CD	Carrier Detect (CMOS Output) . Active low. A logic low indicates the presence of in-band signal at the output of the FSK bandpass filter.
20	INT	Interrupt (Open Drain Output) . Active low. It is active when TRIGout or DR is low, or StD is high. This output stays low until all three signals have become inactive.
21	StD	Dual Tone Alert Signal Delayed Steering Output (CMOS Output) . When high, it indicates that a guard time qualified alert signal has been detected.
22	ESt	Dual Tone Alert Signal Early Steering Output (CMOS Output) . Alert signal detection output. Used in conjunction with St/GT and external circuitry to implement the detect and non-detect guard times.
23	St/GT	Dual Tone Alert Signal Steering Input/Guard Time (Analog Input/CMOS Output) . A voltage greater than V_{TGt} (see Figure 4) at the St/GT pin causes the device to indicate that a dual tone has been detected by asserting StD high. A voltage less than V_{TGt} frees the device to accept a new dual tone.
24	V_{DD}	Positive Power Supply.

The MT88E43 provides all the features and functions offered by Zarlink's MT8841 (CNIC), including 1200 baud Bell 202 and CCITT V.23 FSK demodulation. The 3-wire serial data interface provided by CNIC has been enhanced to operate in two modes. In the CNIC compatible mode data transfer is initiated by the device. A second mode allows a microcontroller to extract 8-bit data words from the device. Furthermore, the MT88E43 offers Idle State Tone Alert Signal and line reversal detection capability for BT's CLIP, ring burst detection for the U.K.'s CCA's CLIP, and ring and CAS detection for Bellcore's CID.

Functional Overview

The MT88E43, Extended Voltage Calling Number Identification Circuit 2 (ECNIC2) is a device compatible with BT, the U.K.'s CCA and Bellcore specifications. As shown in Figure 1, the MT88E43 provides an FSK demodulator as well as a 3-wire serial interface similar to that of it's predecessor, the MT8841 (CNIC). The 3-wire interface has been enhanced to provide two modes of operation - a mode whereby data transfer is initiated by the device and a mode whereby data transfer is initiated by an external microcontroller.

In addition to supporting all the features and functions of the MT8841, the MT88E43 also provides line reversal detection, ring detection and dual tone alert signal/CAS detection. These new functions eliminate some external circuitry previously required with the MT8841.

The MT88E43 is compatible with the caller identity specifications of BT, the U.K.'s CCA, and Bellcore.

BT specifications SIN227 and SIN242 describe the signalling mechanism between the network and the Terminal Equipment (TE) for the Caller Display Service (CDS). CDS provides Calling Line Identity Presentation (CLIP), which delivers to an on hook (idle state) TE the identity of an incoming caller before the first ring.

An incoming CDS call is indicated by a polarity reversal on the A and B wires (see Figure 3), followed by an Idle State Tone Alert Signal. Caller ID FSK information is then transmitted in CCITT V.23 format. MT88E43 can detect the line reversal, tone alert signal, and demodulate the incoming CCITT V.23 FSK signals.

The U.K.'s CCA specification TW/P&E/312 proposes an alternate CDS TE interface. According to TW/P&E/312, data is transmitted after a single burst of ringing rather than before the first ringing cycle (as specified in the BT standards). The Idle State Tone Alert Signal is not required as it is replaced by a single ring burst. MT88E43 has the capability to detect the ring burst. It can also demodulate either Bell-202 or CCITT V.23 FSK data following the ring burst. The U.K.'s CCA specifies that data can be transmitted in either format.

Bellcore specification GR-30-CORE is the generic requirement for transmitting asynchronous voiceband data to Customer Premises Equipment (CPE). Another Bellcore specification SR-TSV-002476 describes the same requirements from the CPE's perspective. The data transmission technique specified in both documents is applicable in a variety of services like Calling Number Delivery (CND), Calling Name Delivery (CNAM) and Calling Identity Delivery on Call Waiting (CIDCW) - services promoted by Bellcore.

In CND/CNAM service, information about a calling party is embedded in the silent interval between the first and second ring burst. The MT88E43 detects the first ring burst and can then be setup to receive and demodulate the incoming Bell-202 FSK data. The device will output the demodulated data onto a 3-wire serial interface.

In CIDCW service, information about an incoming caller is sent to the subscriber, while he/she is engaged in another call. A CPE Alerting Signal (CAS) indicates the arrival of CIDCW information. The MT88E43 can detect the alert signal and then be setup to demodulate incoming FSK data containing CIDCW information.

Functional Description

Detection of CLIP/CID Call Arrival Indicators

The circuit in Figure 3 illustrates the relationship between the TRIGin, $\overline{\text{TRIGRC}}$ and $\overline{\text{TRIGout}}$ signals. Typically, the three pin combination is used to detect an event indicated by an increase of the TRIGin voltage from V_{SS} to above the Schmitt trigger high going threshold V_{T+} (see DC electrical characteristics).

Figure 3 shows a circuit to detect any one of three CLIP/CID call arrival indicators: line reversal, ring burst and ringing.

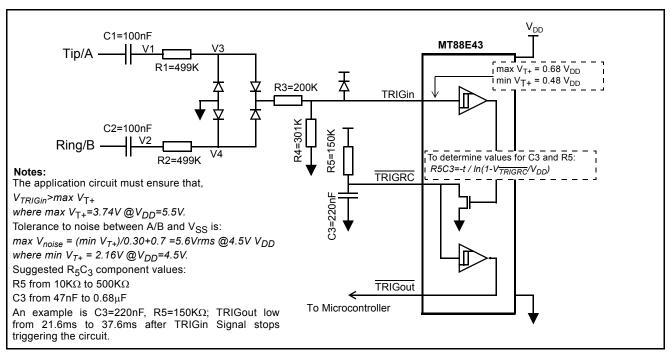


Figure 3 - Circuit to Detect Line Reversal, Ring Burst and Ringing

1. Line Reversal Detection

Line reversal, or polarity reversal on the A and B wires indicates the arrival of an incoming CDS call, as specified in <u>SIN227</u>. When the event (line reversal) occurs, TRIGin rises past the high going Schmitt threshold V_{T+} and TRIGout, which is normally high, is pulled low. When the event is over, TRIGin falls back to below the low going Schmitt threshold V_{T-} and TRIGout returns high. The components R5 and C3 (see Figure 3) at TRIGRC ensure a minimum TRIGout low interval.

In a TE designed for CLIP, the TRIGout high to low transition may be used to interrupt or wake-up the microcontroller. The controller can thus be put into power-down mode to conserve power in a battery operated TE.

2. Ring Burst Detection

CCA does not support the dual tone alert signal (refer to Dual Tone Alert Signal Detection section). Instead, CCA requires that the TE be able to detect a single burst of ringing (duration 200-450 ms) that precedes CLIP FSK data. The ring burst may vary from 30 to 75 Vrms and is approximately 25 Hz.

Again in a TE designed for CCA CLIP, the TRIGout high to low transition may be used to interrupt or wake-up the microcontroller. The controller can thus be put into power-down mode to conserve power in a battery operated TE.

3. Ring Detection

In Bellcore's CND/CNAM scheme, the CID FSK data is transmitted between the first and second ringing cycles. The circuit in Figure 3 will generate a ring envelope signal (active low) at TRIGout for a ring voltage of at least 40 Vrms. R5 and C3 filter the ring signal to provide an envelope output.

The diode bridge shown in Figure 3 works for both single ended and balanced ringing. A fraction of the ring voltage is applied to the TRIGin input. When the voltage at TRIGin is above the Schmitt trigger high going threshold V_{T+} , TRIGRC is pulled low as C3 discharges. TRIGout stays low as long as the C3 voltage stays below the minimum V_{T+} .

In a CPE designed for CND/CNAM, the TRIGout high to low transition may be used to interrupt or wake-up the microcontroller. The controller can thus be put into power-down mode to conserve power.

If precise ring duration determination is critical, capacitor C3 in Figure 3 may be removed. The microcontroller will now be able to time the ring duration directly. The result will be that TRIGout will be low only as long as the ringing signal is present. Previously the RC time constant would cause only one interrupt.

Dual Tone Alert Signal Detection

The BT on hook (idle state) caller ID scheme uses a dual tone alert signal whose characteristics are shown in Table 1.

Bellcore specifies a similar dual tone alert signal called CPE Alerting Signal (CAS) for use in off-hook data transmission (see Table 1). Bellcore states that the CPE should be able to detect the CAS in the presence of near end speech. The CAS detector should also be immune to imitation from near and far end speech.

In the MT88E43 the dual tone alert signal is separated into a high and a low tone by two bandpass filters. A detection algorithm examines the two filter outputs to determine the presence of a dual tone alert signal. The ESt pin goes high when both tones are present. Note that ESt is only a preliminary indication. The indication must be sustained over the tone present guard time to be considered valid. Tone present and tone absent guard times can be implemented with external RC components. The tone present guard time rejects signals of insufficient duration. The tone absent guard time masks momentary detection dropout once the present guard time has been satisfied. StD is the guard time qualified detector output.

ltem	ВТ	Bellcore		
Low tone frequency	2130Hz ±1.1%	2130Hz ±0.5%		
High tone frequency	2750Hz ± 1.1%	$2750 Hz \pm 0.5\%$		
Received signal level	-2dBV to -40dBV per tone on-hook ¹ (0.22dBm ² to -37.78dBm)	-14dBm ^b to - 32dBm per tone off-hook		
Signal reject level	-46dBV (-43.78dBm)	-45dBm		
Signal level differential (twist)	up to 7dB	up to 6dB		
Unwanted signals	<= -20dB (300-3400Hz)	<= -7dBm ASL ³ near end speech		
Duration	88ms to 110ms ⁴	75ms to 85ms		
Speech present	No	Yes		

Table 1 - Dual Tone Alert Signal Characteristics

- In the future BT may specify the off-hook signal level as -15 dBm to -34 dBm per tone for BT CIDCW.
 The signal power is expressed in dBm referenced to 600 ohm at the CPE A/B (tip/ring) interface.
- 3. ASL = active speech level expressed in dBm referenced to 600 ohm at the CPE tip/ring interface. The level is measured according to method B of Recommendation P.56 "Objective Measurement of Active Speech Level" published in the CCITT Blue Book, volume V "Telephone Transmission Quality" 1989. EPL (Equivalent Peak Level) = ASL+11.7 dB
- SIN227 suggests that the recognition time should be not less than 20 ms if both tones are detected.

Dual Tone Detection Guard Time

When the dual tone alert signal is detected by the MT88E43, ESt goes high. When the alerting signal ceases to be detected, ESt goes low.

The ESt pin signals raw detection of CAS/Alerting Tones. Since both Bellcore and BT applications require a minimum duration for valid signals, ESt detection must be guard time qualified. The StD pin provides guard time gualified CAS/Alerting Tone detection. When the MT88E43 is used in a caller identity system, StD indicates correct CAS/Alerting Tone detection.

Figure 4 shows the relationship between the St/GT, ESt and StD pins. It also shows the operation of a guard time circuit.

The total recognition time is $t_{RFC} = t_{GP} + t_{DP}$, where t_{GP} is the tone present guard time and t_{DP} is the tone present detect time (refer to timing between ESt, St/GT and StD in Figures 17 and 20).

The total tone absent time is $t_{ABS} = t_{GA} + t_{DA}$, where t_{GA} is the tone absent guard time and t_{DA} is the tone absent detect time (refer to timing between ESt, St/GT and StD in Figures 17 and 20).

Bellcore states that it is desirable to be able to turn off CAS detection for an off-hook capable CPE. The disable switch allows the subscriber who disconnects a service that relies on CAS detection (e.g., CIDCW) but retains the CPE, to turn off the detector and not be bothered by false detection.

When SW1 in Figure 4 is in the B position the guard time circuit is disabled. The detector will still process CAS/Alerting tones but the MT88E43 will not signal their presence by ensuring StD is low.

BT specifies that the idle state tone alert signal recognition time should not be less than 20 ms when both tones are used for detection. That is, both tones must be detected together for at least 20 ms before the signal can be declared valid. This requirement can be met by setting the t_{GP} (refer to Figure 5) to at least 20 ms.

BT also specifies that the TE is required to apply a D.C. wetting pulse and an AC load 15-25 ms after the end of the alerting signal. If $t_{ABS}=t_{DA}+t_{GA}$ is 15 to 25 ms, the D.C. current wetting pulse and the A.C. load can both be applied at the falling edge of StD. The maximum t_{DA} is 8ms so t_{GA} should be 15-17 ms. Therefore, t_{GP} must be greater than t_{GA} . Figure 5(a) shows a possible implementation. The values in Figures 9 and 11 (R2=R3=422K, C=0.1µF) will meet the BT timing requirements.

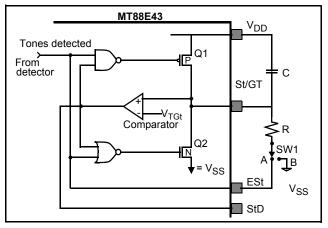


Figure 4 - Guard Time Circuit Operation

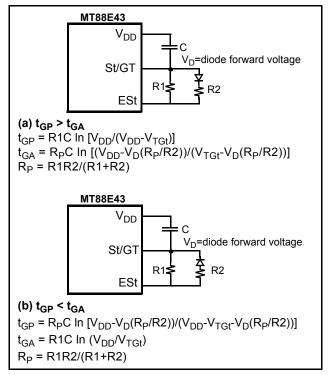


Figure 5 - Guard Time Circuits with Unequal Times

Input Configuration

The MT88E43 provides an input arrangement comprised of an operational amplifier and a bias source (V_{Ref}); which is used to bias the opamp inputs at $V_{DD}/2$. The feedback resistor at the opamp output (GS) can be used to adjust the gain. In a single-ended configuration, the opamp is connected as shown in Figure 6. For a differential input configuration, Figure 7 shows the necessary connections.

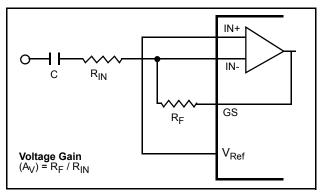


Figure 6 - Single-Ended Input Configuration

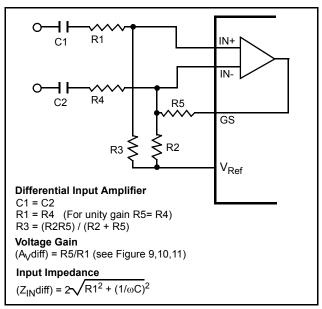


Figure 7 - Differential Input Configuration

FSK Demodulation

The MT88E43 first bandpass filters and then demodulates the incoming FSK signal. The carrier detector provides an indication of the presence of signal at the bandpass filter output. The MT88E43's dual mode 3-wire interface allows convenient extraction of the 8-bit data words in the demodulated FSK bit stream.

Note that signals such as dual tone alert signal, speech and DTMF tones lie in the same frequency band as FSK. They will, therefore, be demodulated and as a result, false data will be generated. To avoid demodulation of false data, an FSKen pin is provided so that the FSK demodulator may be disabled when FSK signal is not expected. There are two events that if either is true, should be used to disable FSKen. The events are CD returning high or receiving all the data indicated by the message length word.

Item	ВТ	Bellcore		
Mark frequency (logic 1)	1300Hz ±1.5%	1200Hz ±1%		
Space frequency (logic 0)	2100Hz ±1.5%	2200Hz ±1%		
Received signal level - mark	-8dBV to -40dBV (-5.78dBm to -37.78dBm)	-12dBm ¹ to -32dBm		
Received signal level - space	-8dBV to -40dBV	-12dBm to -36dBm		

Table 2 - FSK Characteristics

ltem	ВТ	Bellcore			
Signal level differential (twist)	up to 6dB	up to 10dB ²			
Unwanted signals	<= -20dB (300-3400Hz)	<= -25dB (0-4kHz) ³			
Transmission rate	1200 baud ±± 1%	1200 baud ±± 1%			
Word format	1 start bit (logic 0), 8 bit word (LSB first), 1 to 10 stop bits (logic 1)	1 start bit (logic 0), 8 bit word (LSB first), 1 stop bit (logic 1) ⁴			

Table 2 - FSK Characteristics

The signal power is expressed in dBm referenced to 600 ohm at the CPE tip/ring (A/B) interface.
 SR-3004,Issue 2, January 1995.
 The frequency range is specified in GR-30-CORE.
 Up to 20 marks may be inserted in specific places in a single or multiple data measures.

or multiple data message.

The FSK characteristics described in Table 2 are listed in BT and Bellcore specifications. The BT signal frequencies correspond to CCITT V.23. The Bellcore frequencies correspond to Bell 202. The U.K.'s CCA requires that the TE be able to receive both CCITT V.23 and Bell 202, as specified in the BT and Bellcore specifications. The MT88E43 is compatible with both formats without any adjustment.

3-wire User Interface

The MT88E43 provides a powerful dual mode 3-wire interface so that the 8-bit data words in the demodulated FSK bit stream can be extracted without the need either for an external UART or for the TE/CPE's microcontroller to perform the UART function in software. The interface is specifically designed for the 1200 baud rate and is comprised of the DATA, DCLK (data clock) and DR (data ready) pins. Two modes (modes 0 and 1) are selectable via control of the device's MODE pin: in mode 0, data transfer is initiated by the MT88E43; in mode 1, data transfer is initiated the external microcontroller. by

Mode 0

This mode is selected when the MODE pin is low. It is the MT8841 compatible mode where data transfer is initiated by the device.

In this mode, the MT88E43 receives the FSK signal, demodulates it, and outputs the data directly to the DATA pin (refer to Figure 14). For each received stop and start bit sequence, the MT88E43 outputs a fixed frequency clock string of 8 pulses at the DCLK pin. Each clock rising edge occurs in the centre of each DATA bit cell. DCLK is not generated for the stop and start bits. Consequently, DCLK will clock only valid data into a peripheral device such as a serial to parallel shift register or a micro-controller. The MT88E43 also outputs an end of word pulse (data ready) on the DR pin. The data ready signal indicates the reception of every 10-bit word (including start and stop bits) sent from the network to the TE/CPE. This DR signal can be used to interrupt a micro-controller. DR can also cause a serial to parallel converter to parallel load its data into a microcontroller. The mode 0 data pin can also be connected to a personal computer's serial communication port after converting from CMOS to RS-232 voltage levels.

Mode 1

This mode is selected when the MODE pin is high. In this mode, the microcontroller supplies read pulses (DCLK) to shift the 8-bit data words out of the MT88E43, onto the DATA pin. The MT88E43 asserts DR to denote the word boundary and indicate to the microprocessor that a new word has become available (refer to Figure 16).

Internal to the MT88E43, the demodulated data bits are sampled and stored. After the 8th bit, the word is parallel loaded into an 8 bit shift register and \overline{DR} goes low. The shift register's contents are shifted out to the DATA pin on the supplied DCLK's rising edge in the order they were received.

If DCLK begins while \overline{DR} is low, \overline{DR} will return to high upon the first DCLK. This feature allows the associated interrupt (see section on "Interrupt") to be cleared by the first read pulse. Otherwise \overline{DR} is low for half a nominal bit time (1/2400 sec).

After the last bit has been read, additional DCLKs are ignored.

Carrier Detect

The carrier detector provides an indication of the presence of a signal in the FSK frequency band. It detects the presence of a signal of sufficient amplitude at the output of the FSK bandpass filter. The signal is qualified by a digital algorithm before the CD output is set low to indicate carrier detection. An 8ms hysteresis is provided to allow for momentary signal drop out once CD has been activated. CD is released when there is no activity at the FSK bandpass filter output for 8 ms.

When $\overline{\text{CD}}$ is inactive (high), the raw output of the demodulator is ignored by the data timing recovery circuit (refer to Figure 1). In mode 0, the DATA pin is forced high. No DCLK or $\overline{\text{DR}}$ signal is generated. In mode 1, the internal shift register is not updated. No $\overline{\text{DR}}$ is generated. If DCLK is clocked (in mode 1), DATA is undefined.

Note that signals such as dual tone alert signal, speech and DTMF tones also lie in the FSK frequency band and the carrier detector may be activated by these signals. The signals will be demodulated and presented as data. To avoid false data detection, the FSKen pin should be used to disable the FSK demodulator when no FSK signal is expected.

Ringing, on the other hand, does not pose a problem as it is ignored by the carrier detector.

Interrupt

To facilitate interfacing with microcontrollers running interrupt driven firmwear, an open drain interrupt output INT is provided. INT is asserted when TRIGout is low, StD is high, or DR is low. When INT is asserted, these signals should be read (through an input port of the microcontroller) to determine the cause of the interrupt (TRIGout, StD or DR) so that the appropriate response can be made.

When system power is first applied, TRIGout will be low because capacitor C3 at TRIGRC (see Figure 3) has no initial charge. This will result in an interrupt upon power up. Also when system power is first applied and the PWDN pin is low, an interrupt will occur due to StD. Since there is no charge across the capacitor at the St/GT pin in Figure 4, StD will be high triggering an interrupt. The interrupts will not clear until both capacitors are charged. The microcontroller should ignore interrupt from these sources on initial power up until there is sufficient time to charge the capacitors.

It is possible to clear StD and its interrupt by asserting PWDN immediately after system power up. When PWDN is high, StD is low. PWDN will also force both ESt and the comparator output low, Q2 will turn on so that the capacitor at the St/GT pin charges up quickly (refer to Figure 4).

Power Down Mode

For applications requiring reduced power consumption, the MT88E43 can be powered up only when it is required, that is, upon detection of one of three CLIP/CID call arrival indicators: line reversal, ring burst and ringing.

The MT88E43 is powered down by asser<u>ting the PWDN pin. In powerdown mode, the crystal oscillator, opamp and</u> all internal circuitry, except for TRIGin, TRIGRC and TRIGout pins, are disabled. The three TRIG pins are not affected by power down, such that, the MT88E43 can still react to call arrival indicators. The MT88E43 can be powered up by grounding the PWDN pin.

Crystal Oscillator

The MT88E43 requires a 3.579545MHz crystal oscillator as the master timing source.

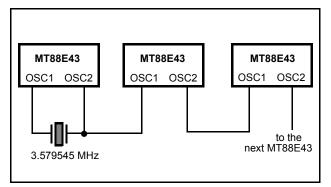


Figure 8 - Common Crystal Connection

The crystal specification is as follows:

Frequency:	3.579545 MHz
Frequency tolerance:	±0.1%(-40°C+85°C)
Resonance mode:	Parallel
Load capacitance:	18 pF
Maximum series resistance:	150 ohms
Maximum drive level (mW):	2 mW
e.g., CTS MP036S	

Any number of MT88E43 devices can be connected as shown in Figure 8 such that only one crystal is required. The connection between OSC2 and OSC1

can be D.C. coupled as shown, or the OSC1 input on all devices can be driven from a CMOS buffer (dc coupled) with the OSC2 outputs left unconnected.

To meet BT and Bellcore requirements for proper tone detection the crystal must have a frequency tolerance of 0.1%.

VRef and CAP Inputs

 V_{Ref} is the output of a low impedance voltage source equal to $V_{DD/2}$ and is used to bias the input opamp. A $0.1 \mu F$ capacitor is required between CAP and V_{SS} to eliminate noise on $V_{Ref.}$

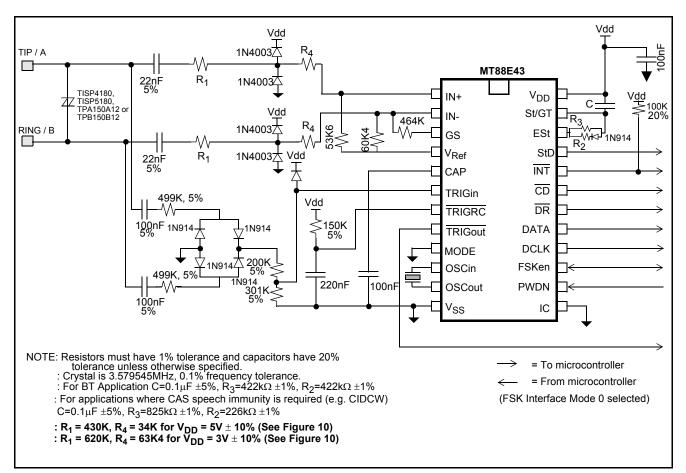


Figure 9 - Application Circuit

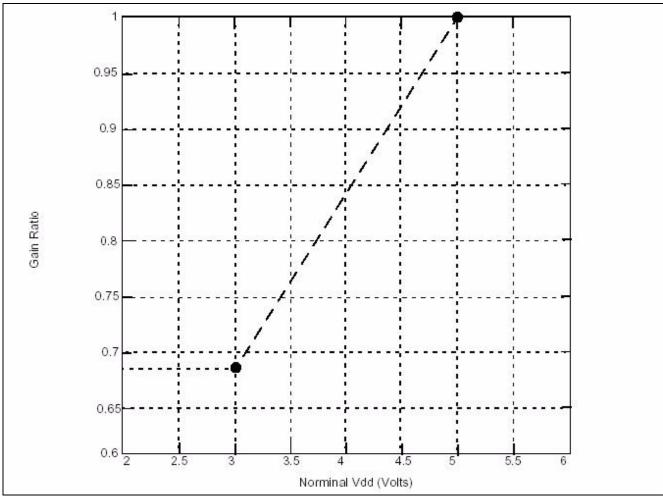
Application Circuits

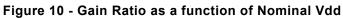
The circuits shown in Figures 9 and 11 are application circuits for the MT88E43. As supply voltage (V_{DD}) is decreased, the threshold of the device's tone and FSK detectors will be reduced. Therefore, to meet the BT or Bellcore tone reject level requirements the gain of the internal opamp should be reduced according to the graph in Figure 10. For example when V_{DD}=5V (+/- 10%), R₁ should equal 430 k Ω and R₄ should equal 34 k Ω ; and if V_{DD}=3V (+/- 10%) R₁ should equal 620 k Ω and R₄ should equal 63.4 k Ω . Resistors R₁ and R₄ are shown in Figures 9 and 11.

The circuit shown in Figure 9 illustrates the use of the MT88E43 in a proprietary system that doesn't need to meet FCC, DOC, and UL approvals. It should be noted that if glitches on the tip/ring interface are of sufficient amplitude, the circuit will falsely detect these signals as ringing or line reversal.

The circuit shown in Figure 11 will provide common mode rejection of signals received by the ringing circuit. This circuit should pass safety related tests specified by FCC Part 68, DOC CS-03, UL 1459, and CSA C22.2. These safety tests will simulate high voltage faults that may occur on the line. The circuit provides isolation from these high voltage faults via R1 and the $12 k1\Omega$ resistors as well as the 22 nF & 330 nF capacitors. IRC manufactures a resistor (part number GS3) that should be used for R1. This resistor is a 3 W, 5%, 1 kV power resistor. The 12 k1 resistor is manufactured by IRC (part number FA8425F). This resistor is a 1.5 W, 5%, fuseable type resistor. The 22 nF and 330 nF capacitors have a 400 V rating.

See the application note "MSAN-164: Applications of the MT8843 Calling Number Identification Circuit 2" for information on designing the MT88E43 into CID and CIDCW systems.





Note: In the application circuits shown in Figures 9 and 11, the Gain Ratio of MT88E43 opamp is

GainRatio = $\frac{464k\Omega}{R_1 + R_4}$

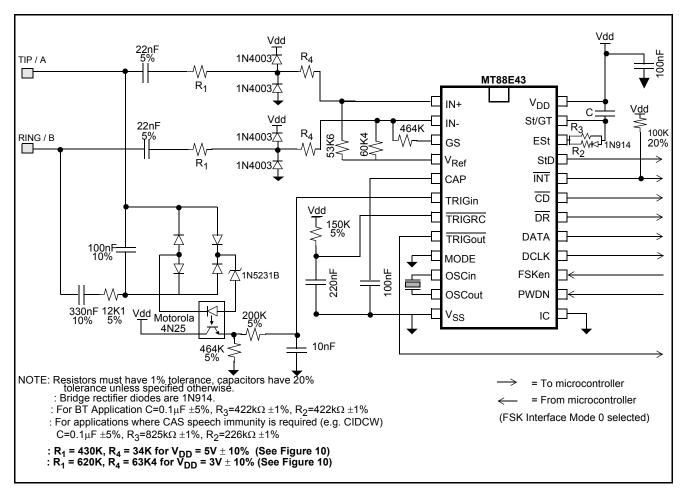


Figure 11 - Application Circuit with Improved Common Mode Noise Immunity and Isolation in Line Interface

Approvals

FCC Part 68, DOC CS-03, UL 1459, and CAN/CSA-22.2 No. 225-M90 are all system (i.e. connectors, power supply, cabinet, etc.) requirements. Since the MT88E43 is a component and not a system, the application circuit (Figure 11) has been designed to meet the CO Trunk interface requirements of FCC, DOC, UL, and CSA; thus enabling the complete system to be approved by these standards bodies.

Products are designed in accordance with meeting the above requirements; however, full conformance to these standards is dependent upon the application in which the MT88E43 is being used, and therefore, approvals are the responsibility of the customer and Zarlink will not have tested the product to meet the above standards.

Parameter Symbol Min. Max. Units 1 Supply voltage with respect to V_{ss} -0.3 6 V V_{DD} 2 V_{ss} -0.3 V_{DD}+0.3 Voltage on any pin other than supplies V_{PIN} V 3 Current at any pin other than supplies 10 mΑ I_{PIN} 4 Storage Temperature T_{ST} -65 150 °C

Absolute Maximum Ratings* - Voltages are with respect to V_{SS} unless otherwise stated.

* Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied.

^T Under normal operating conditions voltage on any pin except supplies can be minimum V_{SS}-1V to maximum V_{DD}+1V for an input current limited to less than 200 μA

. Recommended Operating Conditions - Voltages are with respect to ground (V_{SS}) unless otherwise stated.

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units
1	Power Supplies	V_{DD}	2.7	-	5.5	V
2	Clock Frequency	f _{OSC}		3.579545		MHz
3	Tolerance on Clock Frequency	∆fc	-0.1		+0.1	%
4	Operating Temperature	T _{OP}	-40		85	٥C

‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

DC Electrical Characteristics[†]

		Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	S	Standby Supply Current	I _{DDQ}		0.5	15	μΑ	All inputs are V_{DD}/V_{SS} except for oscillator pins. No analog input. outputs unloaded. PWDN= V_{DD}
2	U P L Y	Operating Supply Current $V_{DD} = 5V \pm 10\%$ $V_{DD} = 3V \pm 10\%$	I _{DD}		4.7 2.5	8 4.5	mA mA	All inputs are V_{DD}/V_{SS} except for oscillator pins. No analog input. outputs unloaded. PWDN=V_{SS} FSKen=V _{DD}
3		Power Consumption	PO			44	mW	
4	TRIGin,	Schmitt Input High Threshold	V_{T+}	0.48*V _{DD}		0.68*V _{DD}	V	
	TRIGRC , PWDN	Schmitt Input Low Threshold	V _{T-}	0.28*V _{DD}		0.48*V _{DD}	V	
5		Schmitt Hysteresis	V _{HYS}	0.2			V	
6	DCLK, MODE,	CMOS Input High Voltage	V _{IH}	0.7*V _{DD}		V _{DD}	V	
	FSKen	CMOS Input Low Voltage	V_{IL}	V_{SS}		0.3*V _{DD}	V	

DC Electrical Characteristics[†] (continued)

		Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
7	TRIGout , DCLK, DATA, DR, CD, StD, ESt, St/GT	Output High Sourcing Current	I _{OH}	0.8			mA	V _{OH} =0.9*V _{DD}
8	TRIGout , DCLK, DATA, DR, CD, StD, ESt, St/GT TRIGRC , INT	Output Low Sinking Current	I _{OL}	2			mA	V _{OL} =0.1*V _{DD}
9	IN+, IN-, TRIGin	Input Current	lin1			1	μA	V_{in} =V _{DD} to V _{SS}
	PWDN, DCLK, MODE, FSKen		lin2			10	μA	$V_{in}=V_{DD}$ to V_{SS}
10	TRIGRC	Output High-Impedance	loz1			1	μA	V_{out} =V _{DD} to V _{SS}
11	INT	Current	loz2			10	μA	
12	St/GT		loz3			5	μΑ	
13	V _{Ref}	Output Voltage	V _{Ref}	0.5V _{DD} - 0.05		0.5V _{DD} + 0.05	V	No Load
14		Output Resistance	R _{Ref}			2	kΩ	
15	St/GT	Comparator Threshold Voltage	V _{TGt}	0.5V _{DD} - 0.05		0.5V _{DD} + 0.05	V	

DC Electrical Characteristics are over recommended operating conditions unless otherwise stated.
 Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

AC Electrical Characteristics[†] - Dual Tone Alert Signal Detection

	Characteristic	Sym.	Min.	Typ.‡	Max.	Unit	Notes*
1	Low tone frequency	fL	-	2130	-	Hz	
2	High tone frequency	f _H	-	2750	-	Hz	
3	Frequency deviation accept		1.1%	-	-		range within which tones are accepted
4	Frequency deviation reject		3.5%	-	-		ranges outside of which tones are rejected
5	Accept signal level per tone		-40 -37.78	-	-2 0.22	dBV ¹ dBm ²	See Note 3

AC Electrical Characteristics[†] - Dual Tone Alert Signal Detection

	Characteristic	Sym.	Min.	Typ.‡	Max.	Unit	Notes*
6	Reject signal level per tone		-	-	-46 -43.78	dBV dBm	See Note 3
7	Positive and negative twist accept		7	-	-	dB ³	
8	Signal to Noise Ratio	SNR _{TONE}	20	-	-	dB	1,2

1. dBV = decibels above or below a reference voltage of 1Vrms. Signal level is per tone. 2. dBm = decibels above or below a reference power of 1mW into 600 ohms, 0 dBm = 0.7746Vrms. Signal level is per tone. 3. Twist = 20 log (f_H amplitude / f_L amplitude).

*Notes:

1. Both tones have the same amplitude.

2. Band limited random noise 300-3400Hz. Measurement valid only when tone is present.

3. With gain setting as shown in Figure 10. Production tested at $3V \pm 10\%$, $5V \pm 10\%$.

=AC Electrical Characteristics are over recommended operating conditions, unless otherwise stated. ‡Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing

AC Electrical Characteristics - Timing Parameter Measurement Voltage Levels

	Characteristics	Sym	Level	Units	Notes
1	CMOS Threshold Voltage	V _{CT}	0.5*V _{DD}	V	
2	Rise/Fall Threshold Voltage High	V _{HM}	0.7*V _{DD}	V	
3	Rise/Fall Threshold Voltage Low	V _{LM}	0.3*V _{DD}	V	

Elec	Electrical Characteristics [†] - Gain Setting Amplifier									
	Characteristics	Sym.	Min.	Max.						

	Characteristics	Sym.	Min.	Max.	Units	Test Conditions
1	Input Leakage Current	I _{IN}		1	μA	$V_{SS} \le V_{IN} \le V_{DD}$
2	Input Resistance	R _{in}	10		MΩ	
3	Input Offset Voltage	V _{OS}		25	mV	
4	Power Supply Rejection Ratio	PSRR	40		dB	1kHz ripple on V _{DD}
5	Common Mode Rejection	CMRR	40		dB	$V_{CMmin} \leq V_{IN} \leq V_{CMmax}$
6	DC Open Loop Voltage Gain	A _{VOL}	30		dB	
7	Unity Gain Bandwidth	f _C	0.3		MHz	
8	Output Voltage Swing	Vo	0.5	V _{DD} -0.5	V_{pp}	$\text{Load} \geq 50 \text{k}\Omega$
9	Maximum Capacitive Load (GS)	CL		100	pF	
10	Maximum Resistive Load (GS)	R _L	50		kΩ	
11	Common Mode Range Voltage	V _{CM}	1.0	V _{DD} -1.0	V	

† Electrical characteristics are over recommended operating conditions, unless otherwise stated.

AC Electrical Characteristics[†] - FSK Detection

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Notes*
1	Input Detection Level		-40 -37.78 10.0		-8 -5.78 398.1	dBV ¹ dBm ² mVrms	1,3
2	Transmission Rate		1188	1200	1212	baud	
3	Input Frequency Detection Bell 202 1 (Mark) Bell 202 0 (Space) CCITT V.23 1 (Mark) CCITT V.23 0 (Space)		1188 2178 1280.5 2068.5	1200 2200 1300 2100	1212 2222 1319.5 2131.5	Hz Hz Hz Hz	
4	Signal to Noise Ratio	SNR_{FSK}	20			dB	1,2

dBV = decibels above or below a reference voltage of 1 Vrms.
 dBm = decibels above or below a reference power of 1mW into 600 ohms. 0 dBm = 0.7746 Vrms.

*Notes

1. Both mark and space have the same amplitude.

2. Band limited random noise (200-3400Hz). Present when FSK signal is present. Note that the BT band is 300-3400Hz, the Bellcore

band is 0-4kHz. 3. Production tested at V_{DD}=3V \pm 10%, 5V \pm 10%.

AC Electrical Characteristics are over recommended operating conditions, unless otherwise stated.
Typical figures are nominal values and are for design aid only: not guaranteed and not subject to production testing.

AC Electrical Characteristics[†] - Dual Tone Alert Signal Timing

	Characteristics	Sym	Min	Max	Units	Notes*
1	Alert Signal present detect time	t _{DP}	0.5	10	ms	1
2	Alert Signal absent detect time	t _{DA}	0.1	8	ms	1

*Notes

1. Refer to Figures 1716 and 19

AC Electrical Characteristics[†] - 3-Wire Interface Timing

		Characteristics	Sym.	Min.	Max.	Units	Notes
1	PWDN	Power-up time	t _{PU}		50	ms	
2	OSC1	Power-down time	t _{PD}		1	ms	
3		Input FSK to $\overline{\text{CD}}$ low delay	t _{CP}		25	ms	
4	CD	Input FSK to $\overline{\text{CD}}$ high delay	t _{CA}	8		ms	
5		Hysteresis		8		ms	

† AC Electrical Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - 3-Wire Interface Timing (Mode 0)

		Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Notes*
1		Rise time	t _{RR}			200	ns	into 50 pF Load
2	DR	Fall time	t _{RF}			200	ns	into 50 pF Load
3		Low time	t _{RL}	415	416	417	μS	2
4	DATA	Rate		1188	1200	1212	baud	1
5	DAIA	Input FSK to DATA delay	t _{IDD}		1	5	ms	
6		Rise time	t _R			200	ns	into 50 pF Load
7	DATA	Fall time	t _F			200	ns	into 50 pF Load
8	DCLK	DATA to DCLK delay	t _{DCD}	6	416		μS	1, 2, 3
9		DCLK to DATA delay	t _{CDD}	6	416		μS	1, 2, 3
10		Frequency	f _{DCLK0}	1201.6	1202.8	1204	Hz	2
11	DCLK	High time	t _{CH}	415	416	417	μs	2
12		Low time	t _{CL}	415	416	417	μs	2
13	D <u>CL</u> K DR	DCLK to $\overline{\text{DR}}$ delay	t _{CRD}	415	416	417	μS	2

AC Electrical Characteristics are over recommended operating conditions unless otherwise stated.
 Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

*Notes:

1. FSK input data at 1200 ± 12 baud. 2. OSC1 at 3.579545 MHz $\pm 0.1\%$. 3. Function of signal condition.

AC Electrical Characteristics[†] - 3-Wire Interface Timing (Mode 1)

		Characteristics	Sym.	Min.	Max.	Units	Notes
1		Frequency	f _{DCLK1}		1	MHz	
2	DCLK	Duty cycle		30	70	%	
3		Rise time	t _{R1}		20	ns	
4	DCLK,	DCLK low set up to $\overline{\text{DR}}$	t _{DDS}	500		ns	
5	D <u>CL</u> K, DR	DCLK low hold time after $\overline{\text{DR}}$	t _{DDH}	500		ns	

† AC Electrical Characteristics are over recommended operating conditions unless otherwise stated.

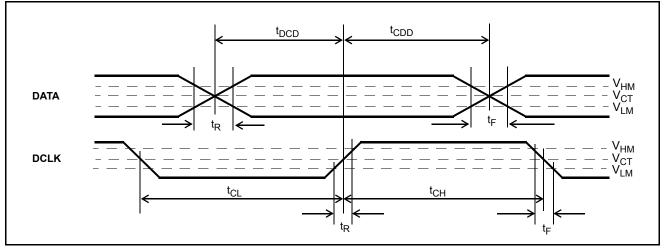


Figure 12 - DATA and DCLK Mode 0 Output Timing

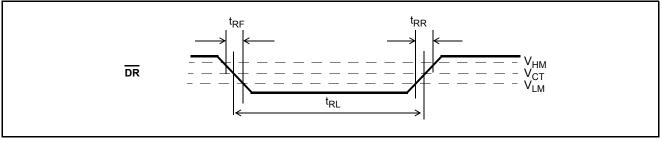


Figure 13 - DR Output Timing

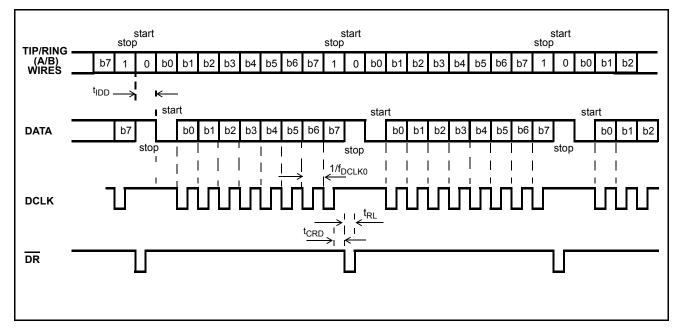


Figure 14 - Serial Data Interface Timing (MODE 0)

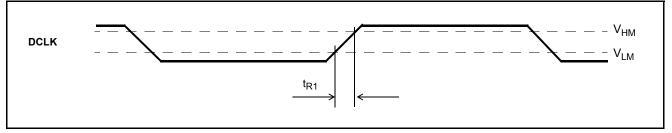
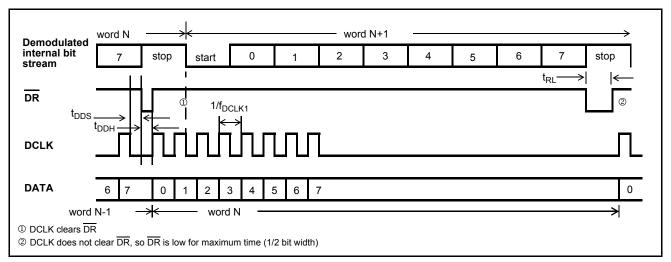


Figure 15 - DCLK Mode 1 Input Timing





Line Reversa		erting Signal						
			1	Ch. seizure	Mark	Data Packet	1	Ring
A/B Wires	Α	В	С	D	E	F	G	
TRIGout Note 1				Note 2				Note 6
PWDN								
ESt	t _{DP} →					\longrightarrow	← 50-1	50ms
St/GT	t _{GP} -		→ ← t _{GA} - V _{TGt}					
StD L	t _{REC}	↔ →		Note 3				
TE DC load	<12	0 μ μΑ	→ < 15±1m	<	0.5mA (optional)	 	
TE AC load		20±5ms		Zss (Refer to			No	ote 4
FSKen			┛				N	ote 5
			→ 	← t _{CP}		\rightarrow	t _c	
DR				•••		•••		A ≥ 100ms B = 88-110ms C ≥ 45ms (up to 5sec)
DCLK							J	D = 80-262ms E = 45-75ms
DATA				101010		Data	J .	F ≤ 2.5sec (typ. 500ms) G > 200ms
OSCout		ΓU				t _{PD}		Note: All values obtained from SIN227 Issue 1

Figure 17 - Input and Output Timing for BT Caller Display Service (CDS), e.g., CLIP

Notes:

1) The total recognition time is $t_{REC} = t_{GP} + t_{DP}$, where t_{GP} is the tone present guard time and t_{DP} is the tone present detect time (refer to section "Dual Tone Detection Guard Time" on page 6 for details). V_{TGt} is the comparator threshold (refer to Figure 4).

2) The total tone absent time is t_{ABS} = t_{GA} + t_{DA}, where t_{GA} is the tone absent guard time and t_{DA} is the tone absent detect time (refer to section "Dual Tone Detection Guard Time" on page 6 for details). V_{TGt} is the comparator threshold (refer to Figure 4).

3) By choosing t_{GA}=15ms, t_{ABS} will be 15-25 ms so that the current wetting pulse and AC load can be applied right after the StD falling edge.

4) SIN227 specifies that the AC and DC loads should be removed between 50-150 ms after the end of the FSK signal, indicated by CD returning to high. The MT88E43 may also be powered down at this time.

5) FSKen should be set low when FSK is not expected to prevent the FSK demodulator from reacting to other in-band signals such as speech, tone alert signal and DTMF tones.

6) TRIGout is the ring envelope during ringing.

Line Reve	Ring Burst	_	L			First Ring Cycle	
A/B Wires	↓ ↓ A	В	Ch. seizure C	Mark D	Data Packet E	F Note 3	
TRIGout	Note 3				50-150m <u>s</u>		
PWDN	250-400ms						
TE DC load						-	
TE AC load						Note 1	
FSKen		→	← t _{CP}		→	Note 2	
						A = 200-450ms B ≥ 500ms C = 80-262ms	
DCLK -					<u> </u>	D = 45-262ms E ≤ 2.5s (typ. 500)ms)
DATA - OSCout -			101010		Data t _{PD}	→ ← F >200ms Note: Paramete from "CCA Excep Document Issue 3	otions
						+ <u>+</u>	

Figure 18 - Input and Output Timing for CCA Caller Display Service (CDS), e.g., CLIP

Notes:
1) TW/P&E/312 specifies that the AC and DC loads should be removed between 50 to 150 ms after the end of the FSK signal, indicated by CD returning to high. The MT88E43 may also be powered down at this time.
2) FSKen should be set low when FSK is not expected to prevent the FSK demodulator from reacting to other in-band signals such as speech, and DTMF tones.
3) TRIGout represents the ring envelope during ringing.

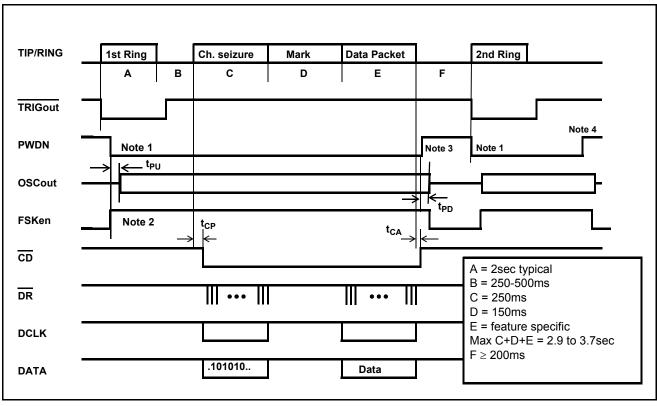


Figure 19 - Input and Output Timing for Bellcore On-hook Data Transmission Associated with Ringing, e.g., CID

Notes:

This on-hook case application is included because a CIDCW (off-hook) CPE should also be capable of receiving on-hook data transmission (with ringing) from the end office. TR-NWT-000575 specifies that CIDCW will be offered only to lines which subscribe to CID.

- 1) The CPE designer may choose to enable the MT88E43 only after the end of ringing to conserve power in a battery operated CPE. CD is not activated by ringing.
- 2) The CPE designer may choose to set FSKen always high while the CPE is on-hook. Setting FSKen low prevents the FSK demodulator from reacting to other in-band signals such as speech, CAS or DTMF tones.
- 3) The microcontroller in the CPE powers down the MT88E43 after \overline{CD} has become inactive.

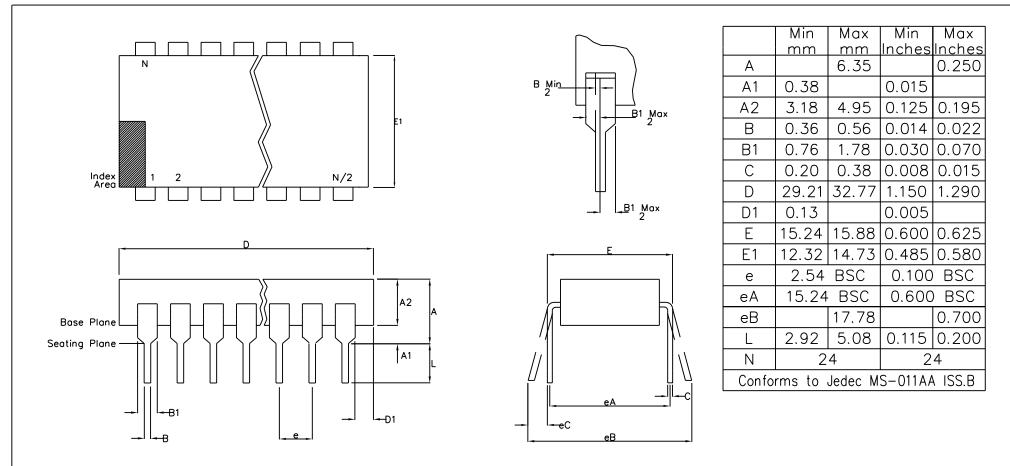
4) The microcontroller times out if $\overline{\text{CD}}$ is not activated.

TIP/RING		PE goes off-	CAS		CPE sends ACK]	Mark	Data Packet	CPE unmutes handset and enables keypad	
PWDN	Note 1	ļ	A	В	С	D Note 5	E	F	G	
FSKen	→	Note 2 ← t _{PU}				Note 3			Note 4	
OSCout ESt	[t _{DP}		· ← t _{DA}		1 				
ESt St/GT	-	t _{GP}		→ ← t _{GA} V _{TGt}						
StD (Note 6)	! <u>=</u>	t _{REC}	Note 7 Note	LABS	;	∎ t _{CP} →	_←	;	> ← t _{CA}	
DR								•••	A = 75-85ms B = 0-100ms C = 55-65ms	
DCLK									D = 0.500 ms $E = 58.75 ms$ $F = feature specific$	c
DATA								Data	G ≤ 50ms	5

Figure 20 - Input and Output Timing for Bellcore Off-hook Data Transmission, e.g., CIDCW

Notes:

- 1) In a CPE where AC power is not available, the designer may choose to switch over to line power when the CPE goes off-hook and use battery power while on-hook. The CPE should also be CID (on-hook) capable because TR-NWT-000575 specifies that CIDCW will be offered only to lines which subscribe to CID.
- 2) Non-FSK signals such as CAS, speech and DTMF tones are in the same frequency band as FSK. They will be demodulated and give false data. The FSKen pin should be set low to disable the FSK demodulator when FSK is not expected.
- 3) FSKen may be set high as soon as the CPE has finished sending the acknowledgment signal ACK. TR-NWT-000575 specifies that ACK = DTMF D for non-ADSI CPE, A for ADSI CPE.
- 4) FSKen should be set low when \overline{CD} has become inactive.
- 5) In an unsuccessful attempt where the end office does not send the FSK signal, the CPE should unmute the handset and enable the keypad after this interval.
- 6) SR-TSV-002476 states that it is desirable that the CPE have an on/off switch for the CAS detector. See SW1 in Figure 4.
- 7) The total recognition time is $t_{REC} = t_{GP} + t_{DP}$, where t_{GP} is the tone present guard time and t_{DP} is the tone present detect time (refer to section "Dual Tone Detection Guard Time" on page 6 for details). V_{TGt} is the comparator threshold (refer to Figure 4).
- 8) The total tone absent time is t_{ABS} = t_{GA} + t_{DA}, where t_{GA} is the tone absent guard time and t_{DA} is the tone absent detect time (refer to section "Dual Tone Detection Guard Time" on page 6 for details). V_{TGt} is the comparator threshold (refer to Figure 4).

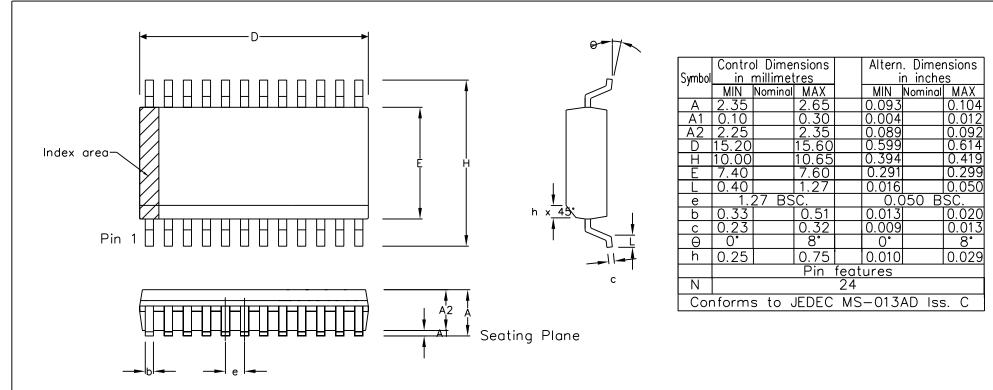


Notes:

- 1. Controlling Dimensions are in inches

- Controlling Dimensions are in increased.
 Dimension A, A1 and L are measured with the package seated in the Seating Plane
 Dimensions D & E1 do not include mould flash or protrusions. Mould flash or protrusion shall not exceed 0.010 inch.
 Dimensions E & eA are measured with leads constrained to be perpendicular to plane T.
 Dimensions eB & eC are measured at the lead tips with the leads unconstrained; eC must be zero or greater.

© Zarlink	Semiconductor	r 2002 All right	s reserved.			Package Code
ISSUE	1	2	3		Previous package codes	Package Outline for
ACN	7010	203400	213101			24 lead PDIP
DATE	20Apr95	4Nov97	15Jul02	JENNICONDOCTOR		
APPRD.						GPD00071



Notes:

- 1. The chamfer on the body is optional. If it not present, a visual index feature, e.g. a dot, must be located within the cross-hatched area.

- Controlling dimension are in millimeters.
 Dimension D do not include mould flash, protrusion or gate burrs. These shall not exceed 0.006" per side.
 Dimension E1 do not include inter-lead flash or protrusion. These shall not exceed 0.010" per side.
 Dimension b does not include dambar protrusion/intrusion. Allowable dambar protrusion shall be 0.004" total in excess of b dimension.

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ISSUE	1	2	3		ZARLINK SEMICONDUCTOR	Previous package codes	Package Outline for
ACN	6746	201942	213099			MP / S	24 lead SOIC (0.300" Body Width)
DATE	7Apr95	27Feb97	15Jul02				
APPRD.							GPD00016



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Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный) **Факс:** 8 (812) 320-02-42 **Электронная почта:** <u>org@eplast1.ru</u> **Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.